

SPECIFICATION

Customer: RICHWELL/OPPO

		Receipt
Item:	Crystal Unit	_
Туре:	NX2016SF	_
Nominal Frequency:	38.4 MHz	_
Customer's Spec. No.:		_
NDK Spec. No.:	EXS00A-CS10536	_

			Revision Record			
Rev.	Rev. Date	Items	Contents	Approved	Checked	Drawn
	29. Mar. 2017	Issue		I. Miyahara		K.Tsukumo

1. Customer Specifications Number

: EXS00A-CS10536

3. Туре

: NX2016SF

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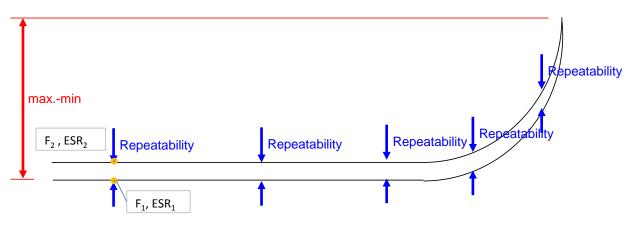
4. Electrical Characteristics

2. NDK Specification Number

	Deremetere	OVM		Electri	cal Spe	С.	Natas
	Parameters	SYM.	Min	TYP	MAX	Units	Notes
1	Nominal frequency	f nom		38.4		MHz	-
2	Overtone order	-	Fu	Indamen	ital	-	AT-CUT
3	Frequency tolerance	-	-10	-	+10	ppm	at +25°C
4	Frequency versus temperature characteristics	-	-12	-	+12	ppm	at -30~+85°C The reference temperature shall be +29°C
5	Equivalent resistance	-	-	-	30	Ω	IEC π-Network / Series
6	Load capacitance	C∟	-	8	-	pF	IEC π-Network
7	Level of drive	DL	10	-	200	μW	-
8	Inflection point	T0	27.5	29	30.5	°C	
9	Constant range	C0	-10	-	10	ppm	
10	1 st order curve fitting parameter	C1	-0.4	-	-0.1	ppm/ºC	
11	2 nd order curve fitting parameter	C2	-4.5	-	+4.5	x 10 ⁻⁴ ppm/⁰C ²	
12	3 rd curve fitting parameter	C3	+8.5	-	+11.5	x 10 ⁻⁵ ppm/⁰C ³	
13	Pulling Sensitivity	PS	10	-	16	ppm/pF	CL=8pF/ Not grounded This value is calculated by following formula. $PS = [ppm/pF] = \frac{Cm \times 1000}{2(C_p + C_L)^2}$ Unit: C _p (pF), C _m (fF) and C _L (pF)
14	Quality factor (Q)	-	75,000	-	-	-	-
15	Spurious mode series resistance	-	1,100	-	-	Ω	±1MHz
16	Aging	-	-0.7	-	0.7	ppm	1 st year
17	Frequency drift after reflow	-	-2	-	2	ppm	after two reflow passed.
18	Insulation resistance	-	500	-	-	MΩ	Terminal to terminal insulation resistance also terminal to cover insulation resistance when DC100V ±15V is applied.
19	Operating temperature range	-	-30	-	+105	°C	-
20	Storage temperature range	-	-40	-	+105	°C	-
21	Air-tightness	-	-	-	1.1×10 ⁻⁹	Pa m ³ /s	Helium leak detector
22	MSL	-	-	-	-	-	MSL 1
23	ESD(HBM)	-	-5	-	+5	ppm	Guarantee voltage: 1000V
24	ESD(MM)	-	-1	-	+1	ppm	Guarantee voltage: 200V

	Measurement condition	Freq.	ESR
Drive level	0.01uW to 100uW to 0.01uW		
Number of points	29 points (15 points up, 15 points down)		
Max. – Min. spec.	Difference between max and min in two way measurement.	<3ppm	<20%
	Freq.: F _{MAX} -F _{MIN}		
	ESR: (ESR _{MAX} -ESR _{MIN})/ESR _{MIN}		
Repeatability spec.	Repeatability of two way measurement in above condition.	<0.7ppm	<10%
	Freq.: F ₂ -F ₁		
	ESR: (ESR ₂ -ESR ₁)/ESR ₁		
	ESR1: first measurement on each drive levels		
	ESR ₂ : second measurement on each drive levels		

5. Drive level dependency (DLD) : Measurement method and specs are defined below.



6. 1. Residual frequency stability slope : ±50 ppb/°C Max.

Condition 1A - Test condition (continuous temperature rate change of ~1.0°C/min)

 The residual is defined as the difference between the crystal measured FT curve and the 5th order polynomial fit of the FT curve. Frequency is measured between
 -30 to +85°C every 1°C. Residual slope is calculated by the formula below.

$$FIT\Delta f(t_{N}) = a(t_{N} - t_{o})^{5} + b(t_{N} - t_{o})^{4} + c(t_{N} - t_{o})^{3} + d(t_{N} - t_{o})^{2} + e(t_{N} - t_{o}) + f$$

$$t_{1} = -30, t_{2} = -29 \cdot \cdot t_{114} = +84, t_{115} = +85^{\circ}C$$

$$t_{0} = +29^{\circ}C$$

 $RES(t_{N}) = F(t_{N}) - FIT\Delta f(t_{N})$ $RES_SLP = RES(t_{N+1}) - RES(t_{N})$

6.2. 5°C small hysteresis 1 $\pm 50 \text{ ppb/°C}$ Max. Ta = -30 to +85°C

Condition1B test condition (continuous temperature rate change of ~1.0°C/min.)

- Measure FT points every 0.5°C while cycling temperature over a 5°C small temperature orbit, an example 5°C small orbit temperature cycle is +30°C to +35°C to +30°C.
- During every individual heating/cooling cycle there should be 11 points; discard the first point of each heating and cooling cycle; this leaves 10 points for each heating and cooling cycle.

- Subtract the fifth-order polynomial best fit from 1A for each of the 10 points, and then calculate the slope of the residual for each of these heating and cooling 10 point curves.
- The residual slope should be within +/-50 ppb/°C.

6.3. 5°C small orbit hysteresis 2 : 100 ppb (magnitude) peak-peak. Ta = -30 to +85°C

Condition 2 test condition (continuous temperature rate change of ~1.0°C/min.)

- Measure FT points every 0.5°C while cycling temperature over a 5°C small temperature orbit, an example 5°C small orbit temperature cycle is +30°C to +35°C to +30°C.
- During every individual heating/cooling cycle there should be 11 points; discard the first and last point of each heating and cooling cycle, which results in 9 temperature points. Calculate the average measured peak-to-peak frequency difference for these 9 temperature points.
- The average difference is the magnitude of the small orbit hysteresis 2.
- The temperature is based on thermistor.

7. Thermistor characteristics

.6×0.3×0.15 (mm)
00 (kΩ) ±1%
250 (K) ±1%
00 (mW) Max.

8. Examination results document

Since a performance is guaranteed, an examination results document does not submit.

9. Application drawing

9.1. Dimension Drawing	: EXD14B-00584
9.2. Taping and Reel figure	: EXK17B-00371
9.3. Holder Marking	: EXH11B-00319
9.4. Packing Label	: EXK17B-00422
9.5. Reliability assurance Item	: EXS30B-01042

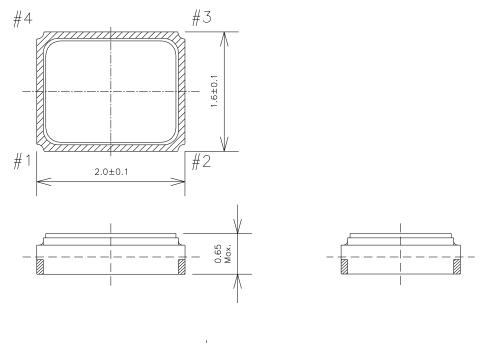
10. Notice

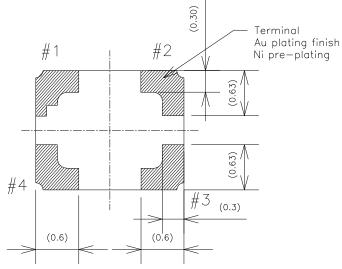
- 10.1. Order items are manufactured according to specification. As to conditions, which are not indicated in this specification and unpredictable such as applied condition and oscillation margin, please check them beforehand.
- 10.2. Unless we receive request for modification within 3 weeks from the issue date of this NDK specification sheet, we will supply products according to this specification. Also, if you'd like to modify specification of order, which has been placed with delivery request within 3 weeks from the issue data of this specification sheet, we would like to discuss with you separately.
- 10.3. In no event shall the company be liable for any product failure resulting from an inappropriate handling or operation of the product beyond the scope of its guarantee.
- 10.4. Where any change to the process condition is made due to the change(s) in the production line, inform personnel of the specifications.

- 10.5 Should this specification data give rise to any disputes relating to any intellectual property rights or any other rights of a third person, the company shall not indemnify anyone for any damage. Their disclosure must not be construed as the grant of a license to use any of the intellectual property rights owned by the company.
- 10.6. If you intend to use products listed on this specification for applications that may result in loss of life or assets (controls relating to safety, medical equipment, aeronautical equipment, space equipment, etc.), please do not fail to advise us of your intention beforehand.
- 10.7. In the company's production process whatever amount of ozone depleting substances (ODS) as specified in the Montreal protocol is not used.
- 10.8. Information contained in this specification must not be quoted, reproduced or used for other purposes including processing either in part or in full without obtaining prior approval from the company.
- 10.9. Crystal units will be damaged by ultrasonic welding process due to resonance of crystal wafer itself. NDK does not recommend using ultrasonic welding. If Ultra Sonic welding used, NDK strongly recommend verifying crystal unit damage by ultrasonic weld.
- 10.10. The appearance color has a different case by purchasing it more than 2 suppliers of the component, but characteristic and reliability are guaranteed.
- 10.11. In case of the product long time keep at high temperature and humidity, may affect product characteristic (solder ability) and a packing condition. Please keep at storage condition of temperature +5°C ~+35°C, humidity ~85%RH.
- 11. Prohibited items

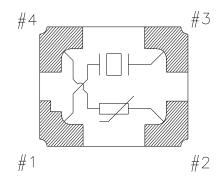
Be sure to use the product under the following conditions. Otherwise, the characteristics deterioration or destruction of the product may result.

- (1) Reflow soldering heat resistance Peak temperature: 265°C, 10 sec Heating: 230°C or higher, 40 sec Preheating: 150°C to 180°C, 120 sec Reflow passage times: three times
- (2) Manual soldering heat resistance
 Pressing a soldering iron of 400°C on the terminal electrode for four seconds (twice).



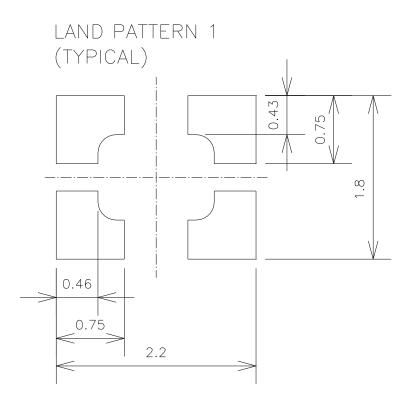


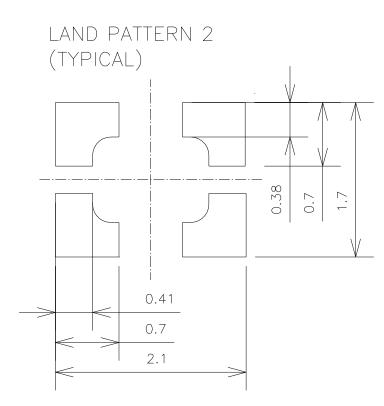
Terminal land connection (TOP VIEW)



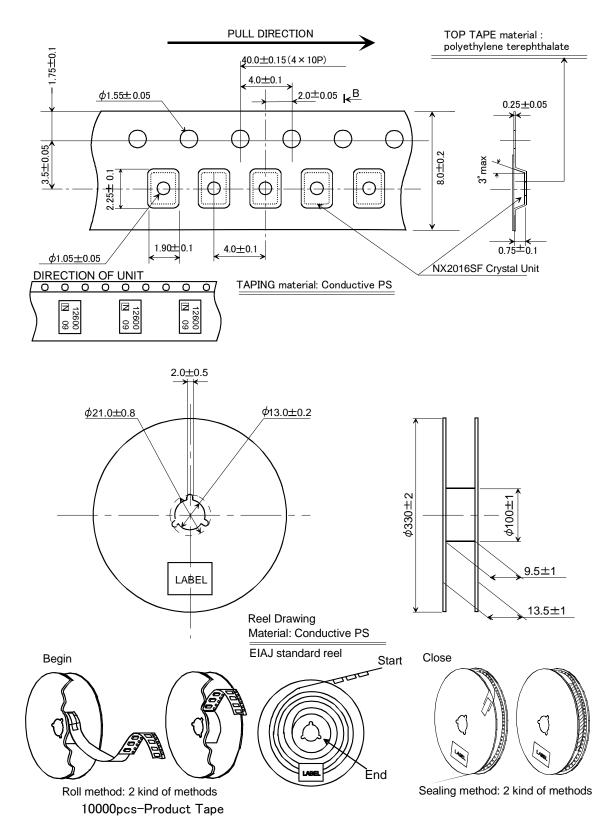
# 1	XTAL IN
#2	THERMISTOR OUT, GND
#3	XTAL OUT
#4	THERMISTOR IN

		Approved	Reason			
Date	Name	Third Angle Projection		Tolerance	Sca	ale
15. Mar. 2013	15. Mar. 2013	Mar. 2013 Dimension:mm				
15. Mar. 2013	15. Mar. 2013	Title		Drawing No.		Rev.
15. Mar. 2013	15. Mar. 2013	NX201	NX2016SF		E01/1/2)	
15. Mar. 2013	15. Mar. 2013	Dimension Drawing		EXD14B-00584(1/2)		
1	5. Mar. 2013 5. Mar. 2013 5. Mar. 2013	5. Mar. 2013 15. Mar. 2013 5. Mar. 2013 15. Mar. 2013 5. Mar. 2013 15. Mar. 2013 5. Mar. 2013 15. Mar. 2013	5. Mar. 2013 15. Mar. 2013 Dimension:m 5. Mar. 2013 15. Mar. 2013 Title 5. Mar. 2013 15. Mar. 2013 Title 5. Mar. 2013 15. Mar. 2013 Dimension:m 5. Mar. 2013 15. Mar. 2013 Dimension:m 5. Mar. 2013 15. Mar. 2013 Dimension	5. Mar. 2013 15. Mar. 2013 Dimension:mm 5. Mar. 2013 15. Mar. 2013 Title 5. Mar. 2013 15. Mar. 2013 Dimension:mm	5. Mar. 2013 15. Mar. 2013 Dimension:mm 5. Mar. 2013 15. Mar. 2013 Title Drawing No. 5. Mar. 2013 15. Mar. 2013 Dimension Drawing EXD14B-00 5. Mar. 2013 15. Mar. 2013 Dimension Drawing EXD14B-00	5. Mar. 2013 15. Mar. 2013 Dimension:mm 5. Mar. 2013 15. Mar. 2013 Title Drawing No. 5. Mar. 2013 15. Mar. 2013 Dimension Drawing EXD14B-00584(1/2) 5. Mar. 2013 15. Mar. 2013 Dimension Drawing EXD14B-00584(1/2)

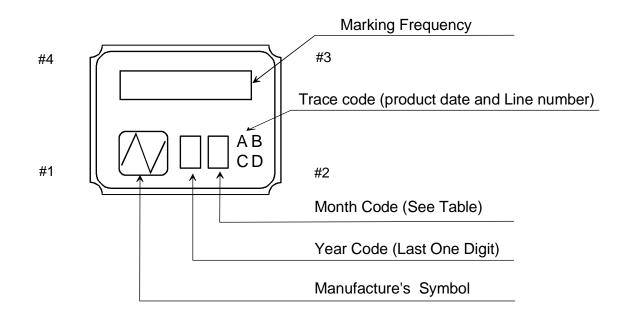




Date of Revise		Charge	Approved	Reason			
	Date	Name	Third Angle Projection		Tolerance		ale
Drawn	15. Mar. 2013	T.Asamizu	Dimension:m	m		/	
Designed	15. Mar. 2013	T.Asamizu	Title		Drawing No.		Rev.
Checked	15. Mar. 2013	I.Miyahara	NX201	NX2016SF		EXD14B-00584(2/2)	
Approved 15. Mar. 2013 M		M.Kubota	Dimension	Drawing			



	Dat	te of Revise	Charge	Approved Reason				
С	27	′ Jan. 2017	H. Ohkubo	H. Murakoshi Change of the p		he product amount.		
		Date	Name	Third Angle Projection To		Tolerance	Sc	ale
Draw	n	30 Jul. 2013	H. Ohkubo	Dimension:mm				/
Desi	gned	30 Jul. 2013	H. Ohkubo	Title		Drawing No.		Rev.
Cheo	cked			NX2016SF		EXK17B-00371		<u> </u>
Appr	oved	30 Jul. 2013	K. Oguri	Taping and Reel Spec.			00371	C



NOTE

1. Month Code Table

Month	1	2	3	4	5	6	7	8	9	10	11	12
	Jan.	Feb.	Mar.	Apr.	May.	Jun.	Jul.	Aug.	Sep.	Oct.	Nov.	Dec.
Month Code	1	2	3	4	5	6	7	8	9	x	Y	Z

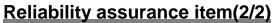
*Marking digits are not include a decimal point and dot mark.

	Dat	e of Revise	Charge	Approved Reason				
Α	10	. Jul. 2008	T.Asamizu	K.Kubota Delete application period.				
		Date	Name	Third Angle Projection To		Folerance	Sc	ale
Drav	vn	14. Feb. 2006	T.Asamizu	Dimension:mm			,	1
Des	igned	14. Feb. 2006	T.Asamizu	Title		Drawing No.		Rev.
Che	cked	14. Feb. 2006	I.Miyahara		Marking			^
Арр	roved	14. Feb. 2006	K.Okamoto	Crystal Holder Marking		EXH11B-00319		A

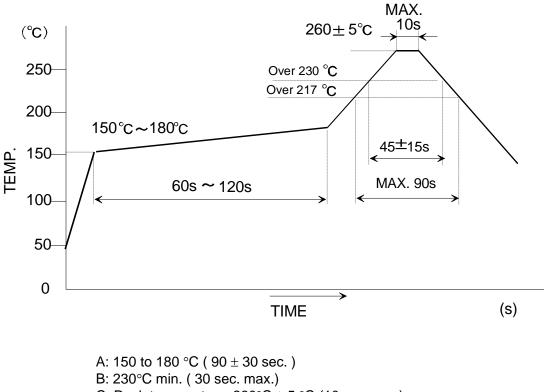
		<u>Rendering doodral</u>	· · · · · · · · · · · · · · · · · · ·	(page: 1/2)
No.	Test Item	Test Methods		Spec. Code
1	High temperature	Temperature: +125 °C Test time: 1000 Hr.		C, D
2	Cold resistance	Temperature: -40 °C Test time: 1000 Hr.		B, D
3	Humidity	at +85 °C with 85 % RH for 1000 hr.		B, D
4	Thermal shock (TS)	-55 +/- 3°C / +125 +/- 3°C 300 cycles/1H per cycles		C, D
5	Vibration	Frequency Range Amplitude or Acceleration 1 cycle Test time	10 to 2000Hz1.52 mm or 10G20 minutesThree mutually perpendicular axes each 6 times.	A, D
6	Bending	Push the center of the substrate down with indenter, speed 1mm/s, bends, 5 mm, the state is held for 5 s +/- 1 s		A, D
7	Shock 1	Shock Height Drop times	Device are put on the weight of 150 g onto concrete. 1.8 m onto concrete. 2 times for each 6 side direct 2 times 8 corners 1 times for each 12 edge directions Totally 26 drops.	B, D
8	Shock 2	Shock Height Equipment Drop times	PCB (36mm '90mm)attached by 6 screws to a housing of 150g. 1.0 m onto concrete 1.0mm +/- 0.1mm thick 300 drops . 12 rotation / min.	B, D
9	Reflow resistance	Temperature cycle as shown in (Fig2.) for 3 cycle.		A, D
10	Air Tightness	Helium leak test.		E

Reliability assurance item (1/2)

Specification code	Specification	
A	Δ F/F $\leq \pm 1.0$ ppm Δ Cl $\leq \pm 15$ % or $\pm 2 \Omega$ greater value	
В	$\Delta F/F \le \pm 2.0 \text{ ppm}$	
	$\Delta CI \le \pm 25$ % or $\pm 2 \Omega$ greater value $\Delta F/F \le \pm 5.0$ ppm	
C	$\Delta CI \le \pm 15$ % or $\pm 2 \Omega$ greater value	
D	Thermistor resistance: $\Delta R/R \le 5\%$	
E	No leak	



Recommended reflow profile



- C: Peak temperature. 260°C \pm 5 °C (10sec. max.)
- D: 217 °C Min. (90 sec. max.)

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